

# ON Semiconductor

## Is Now

The logo for onsemi, featuring the word "onsemi" in a dark teal, lowercase, sans-serif font. The letter "i" is stylized with a white dot and a teal vertical bar. A small orange triangle is positioned above the top right of the "i". A trademark symbol (TM) is located to the right of the logo.

To learn more about onsemi™, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

---

**onsemi** and **onsemi** and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi** product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner. Other names and brands may be claimed as the property of others.

# CM1460

## Praetorian<sup>®</sup> C-L-C LCD and Camera EMI Filter Array with ESD Protection

### Product Description

The CM1460 is a family of pi-style EMI filter arrays with ESD protection, which integrates four, six and eight filters (C-L-C) in small form factor WDFN 0.50 mm pitch packages. Each EMI filter channel of the CM1460 is implemented as a 3-pole L-C filter where the component values are 15 pF – 17 nH – 15 pF. The CM1460's roll-off frequency at –6 dB attenuation is 350 MHz and can be used in applications where the data rates are as high as 140 Mbps while providing greater than 30 dB over the 800 MHz to 2.7 GHz frequency range.

The parts include ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD protection diodes connected to the filter ports are designed and characterized to safely dissipate ESD strikes of ±15 kV, beyond the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30 kV.

This device is particularly well suited for wireless handsets, mobile LCD modules and PDAs because of its small package format and easy-to-use pin assignments. In particular, the CM1460 is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in mobile handsets.

The CM1460 is housed in space saving, low profile, 0.50 mm pitch WDFN packages and is available in lead-free format.

### Features

- Four, Six and Eight Channels of EMI Filtering with Integrated ESD Protection
- Pi-Style EMI Filters in a Capacitor-Inductor-Capacitor (C-L-C) Network
- ±15 kV ESD Protection on Each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- ±30 kV ESD Protection on Each Channel (HBM)
- Greater than –35 dB Attenuation (Typical) at 1 GHz
- WDFN Lead-Free Package with 0.50 mm Lead Pitch:
  - ◆ 4-ch. = 8-lead WDFN
  - ◆ 6-ch. = 12-lead WDFN
  - ◆ 8-ch. = 16-lead WDFN
- Tiny WDFN Package Size:
  - ◆ 8-lead: 2.00 mm x 2.00 mm
  - ◆ 12-lead: 3.00 mm x 1.35 mm
  - ◆ 16-lead: 4.00 mm x 1.60 mm
- Increased Robustness against Vertical Impacts During Manufacturing Process
- These Devices are Pb-Free and are RoHS Compliant



ON Semiconductor<sup>®</sup>

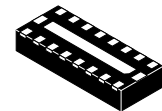
<http://onsemi.com>



WDFN8  
DE SUFFIX  
CASE 511BE

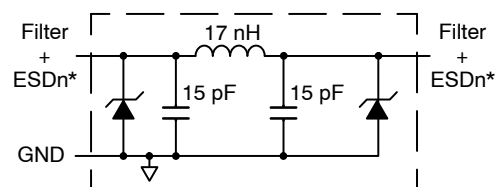


WDFN12  
DE SUFFIX  
CASE 511AZ



WDFN16  
DE SUFFIX  
CASE 511AU

### ELECTRICAL SCHEMATIC



1 of 4, 6 or 8 EMI/RFI Filter Channels  
with Integrated ESD Protection

\* See Package/Pinout Diagrams for expanded pin information.

### MARKING DIAGRAM



XE = CM1460-04DE  
N60E = CM1460-06DE  
N608E = CM1460-08DE

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
CM1460-04DE	WDFN-8 (Pb-Free)	3000/Tape & Reel
CM1460-06DE	WDFN-12 (Pb-Free)	3000/Tape & Reel
CM1460-08DE	WDFN-16 EEP (Pb-Free)	3000/Tape & Reel

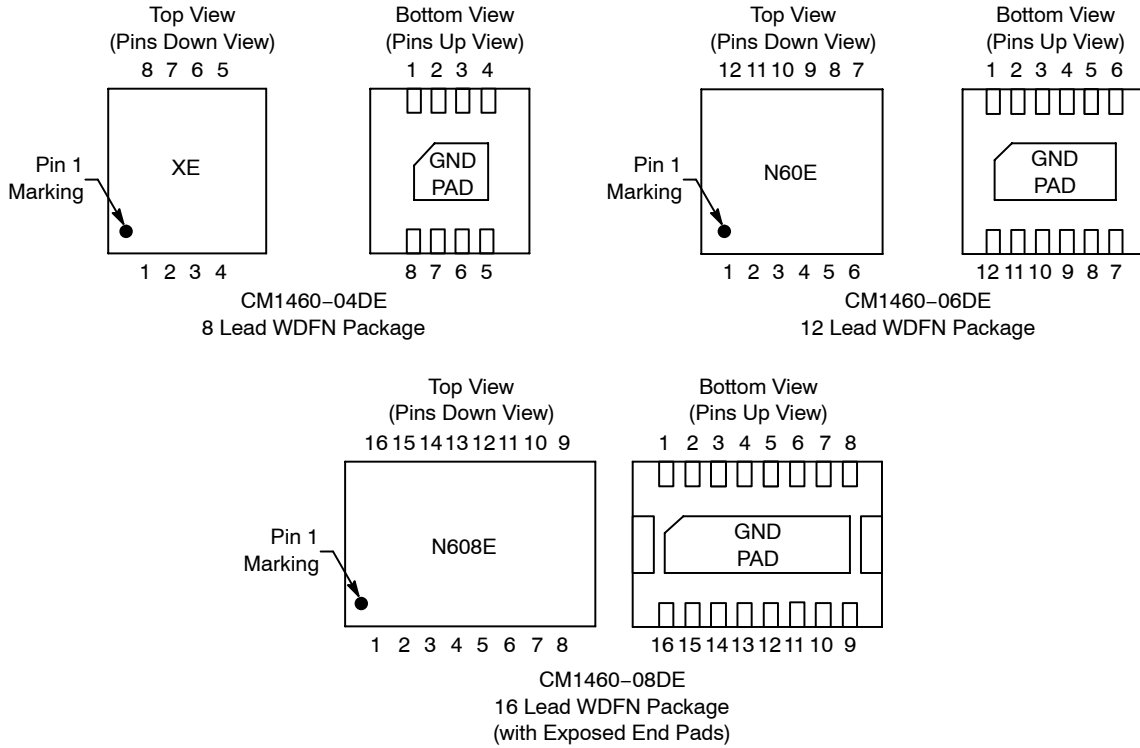
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# CM1460

## Applications

- LCD and Camera Data Lines in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers
- Wireless Handsets
- Handheld PCs/PDAs
- LCD and Camera Modules

## PACKAGE / PINOUT DIAGRAMS



**Table 1. PIN DESCRIPTIONS**

Device Pin(s)			Name	Description	Device Pin(s)			Name	Description
-04	-06	-08			-04	-06	-08		
1	1	1	FILTER1	Filter + ESD Channel 1	8	12	16	FILTER1	Filter + ESD Channel 1
2	2	2	FILTER2	Filter + ESD Channel 2	7	11	15	FILTER2	Filter + ESD Channel 2
3	3	3	FILTER3	Filter + ESD Channel 3	6	10	14	FILTER3	Filter + ESD Channel 3
4	4	4	FILTER4	Filter + ESD Channel 4	5	9	13	FILTER4	Filter + ESD Channel 4
-	5	5	FILTER5	Filter + ESD Channel 5	-	8	12	FILTER5	Filter + ESD Channel 5
-	6	6	FILTER6	Filter + ESD Channel 6	-	7	11	FILTER6	Filter + ESD Channel 6
-	-	7	FILTER7	Filter + ESD Channel 7	-	-	10	FILTER7	Filter + ESD Channel 7
-	-	8	FILTER8	Filter + ESD Channel 8	-	-	9	FILTER8	Filter + ESD Channel 8
GND PAD			GND	Device Ground	-	-	-	-	

# CM1460

## SPECIFICATIONS

**Table 2. ABSOLUTE MAXIMUM RATINGS**

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
Current per Inductor	30	mA
DC Package Power Rating	500	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

**Table 3. STANDARD OPERATING CONDITIONS**

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

**Table 4. ELECTRICAL OPERATING CHARACTERISTICS** (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
L	Channel Inductance			17		nH
C <sub>TOTAL</sub>	Total Channel Capacitance	At 2.5 V DC Reverse Bias, 1 MHz, 30 mV AC	24	30	36	pF
C	Capacitance C1	At 2.5 V DC Reverse Bias, 1 MHz, 30 mV AC		15		pF
V <sub>DIODE</sub>	Stand-off Voltage	I <sub>DIODE</sub> = 10 μA		6.0		V
I <sub>LEAK</sub>	Diode Leakage Current (Reverse Bias)	V <sub>DIODE</sub> = 3.3 V		0.1	1.0	μA
V <sub>SIG</sub>	Signal Clamp Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10 mA I <sub>LOAD</sub> = -10 mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Notes 2 and 3)	±30 ±15			kV
R <sub>DYN</sub>	Dynamic Resistance Positive Negative			2.3 0.9		Ω
f <sub>R</sub>	Roll-off Frequency at -6 dB Attenuation Z <sub>SOURCE</sub> = 50 Ω, Z <sub>LOAD</sub> = 50 Ω			350		MHz

1. T<sub>A</sub> = 25°C unless otherwise specified.

2. ESD applied to input and output pins with respect to GND, one at a time.

3. Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin (i.e. if ESD is applied to pin A1 then clamping voltage is measured at pin C1). Unused pins are left open.

# CM1460

## PERFORMANCE INFORMATION

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

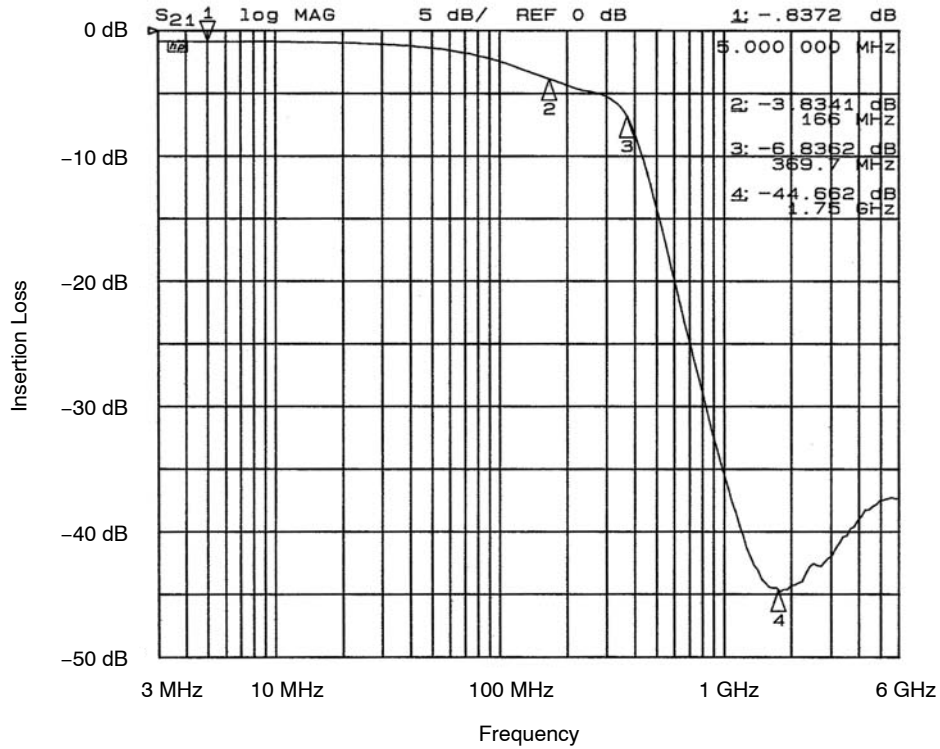


Figure 1. Filter 1 Insertion Loss (CM1460-04DE)

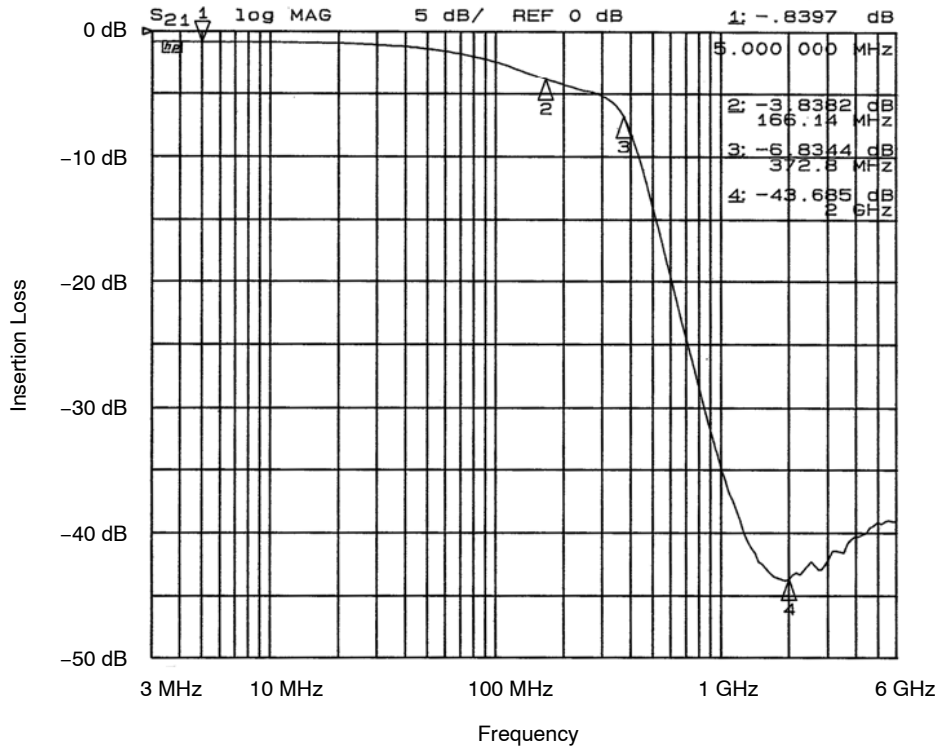


Figure 2. Filter 2 Insertion Loss (CM1460-04DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

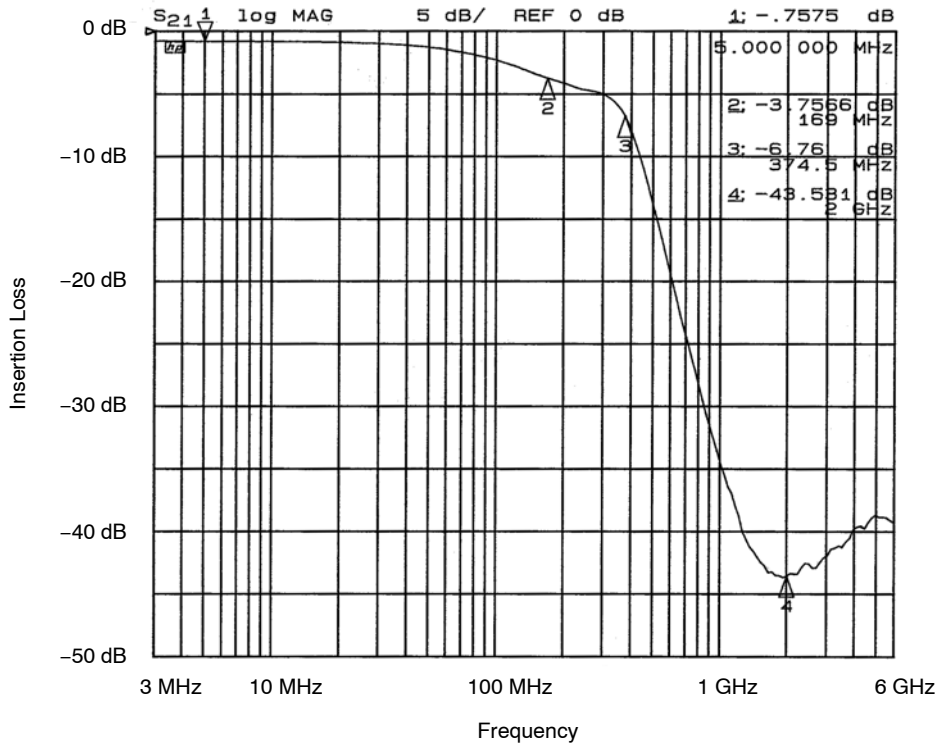


Figure 3. Filter 3 Insertion Loss (CM1460-04DE)

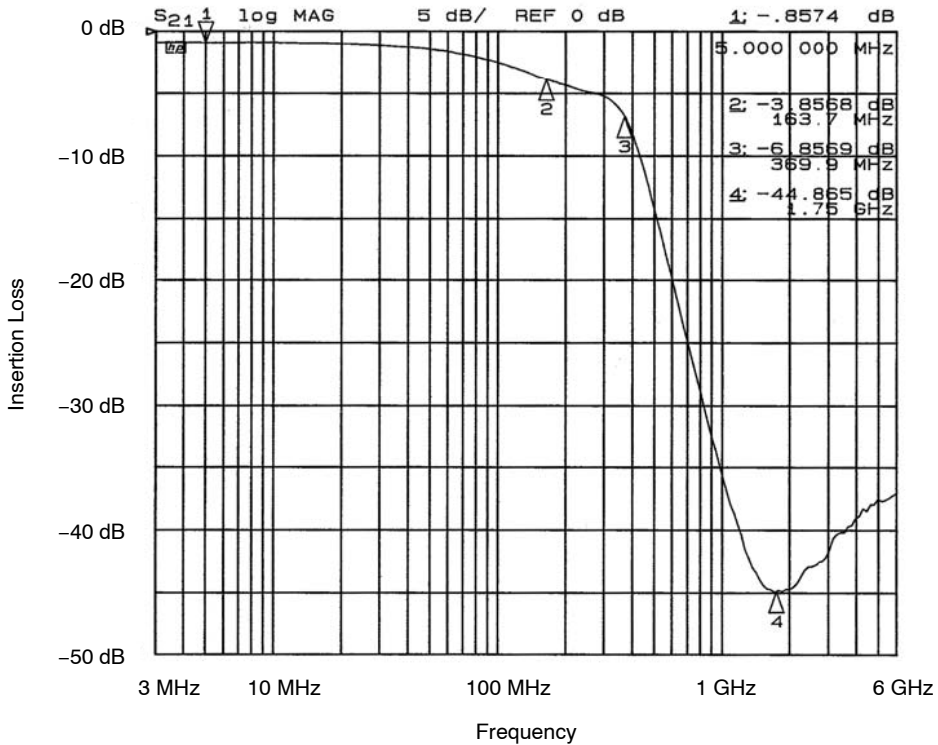


Figure 4. Filter 4 Insertion Loss (CM1460-04DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

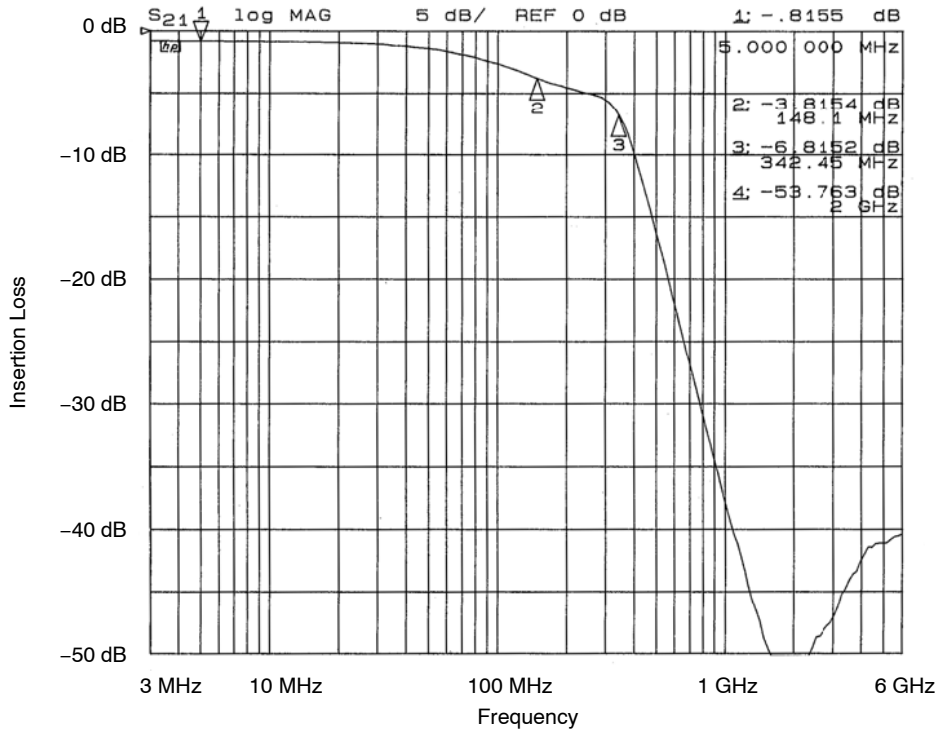


Figure 5. Filter 1 Insertion Loss (CM1460-06DE)

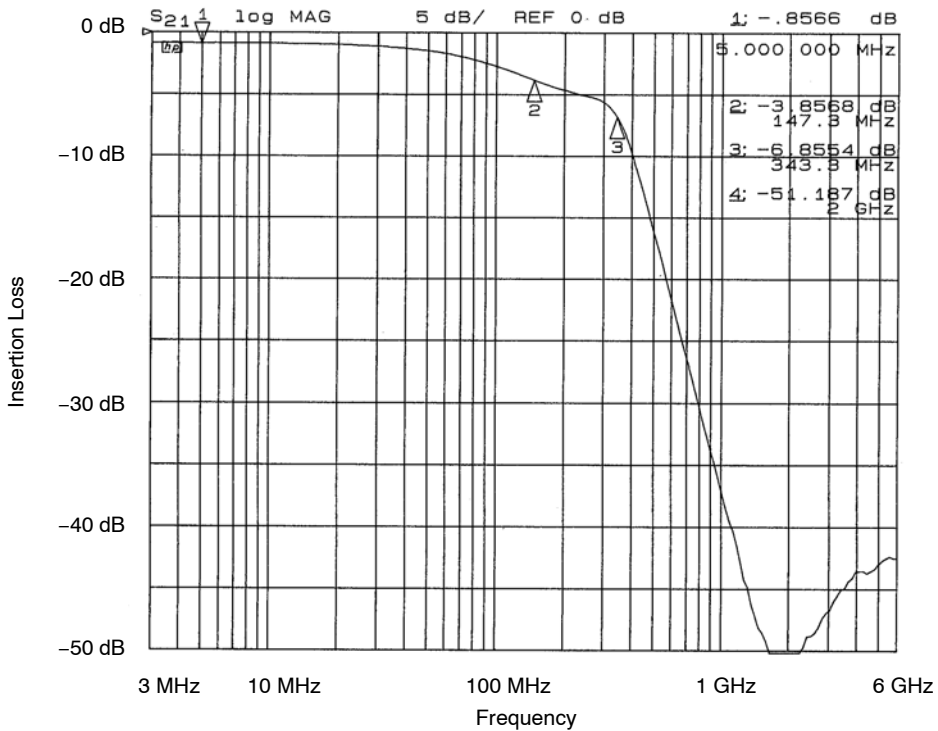


Figure 6. Filter 2 Insertion Loss (CM1460-06DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

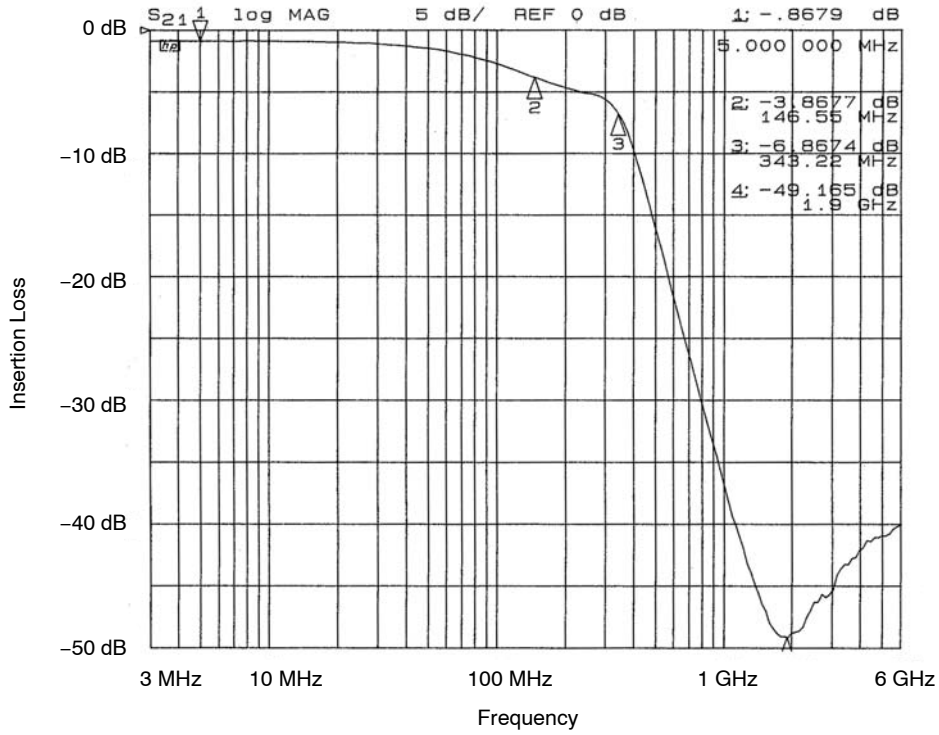


Figure 7. Filter 3 Insertion Loss (CM1460-06DE)

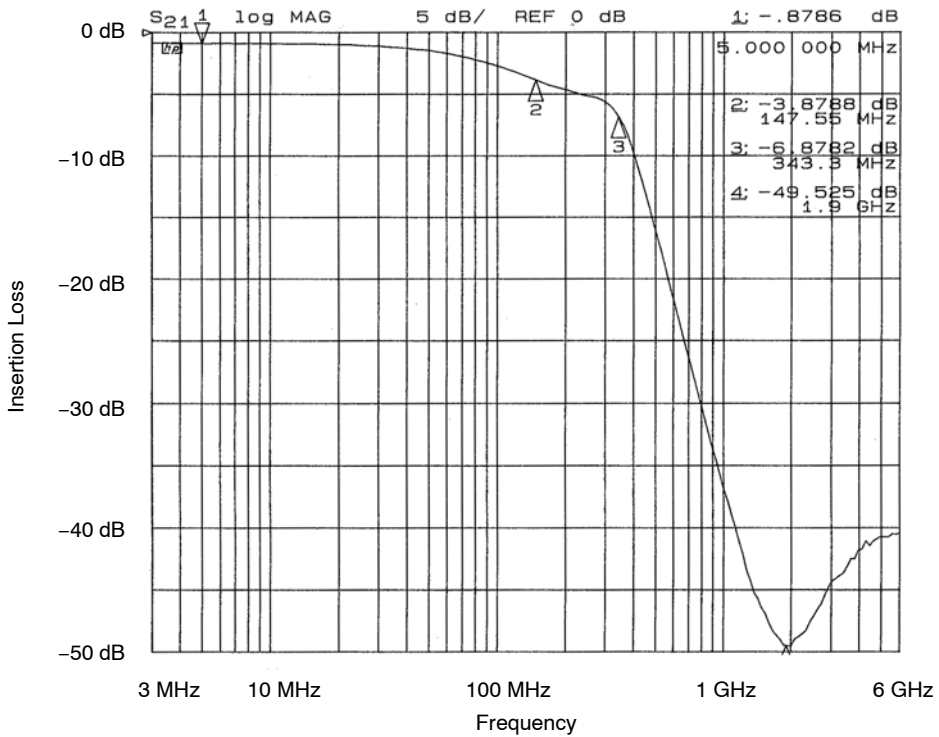


Figure 8. Filter 4 Insertion Loss (CM1460-06DE)



# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

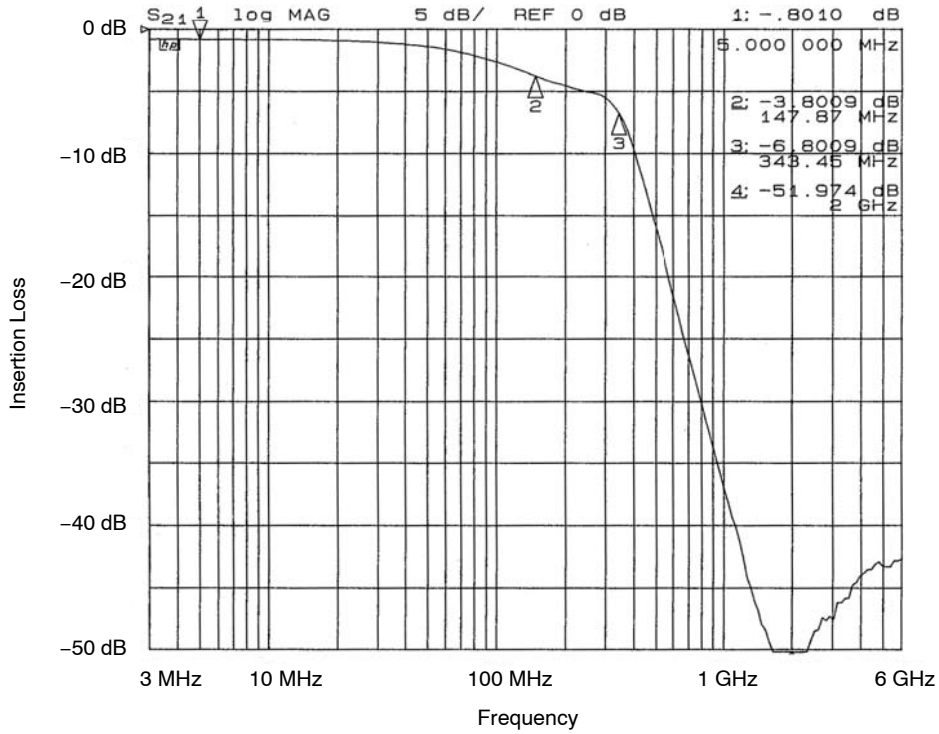


Figure 9. Filter 5 Insertion Loss (CM1460-06DE)

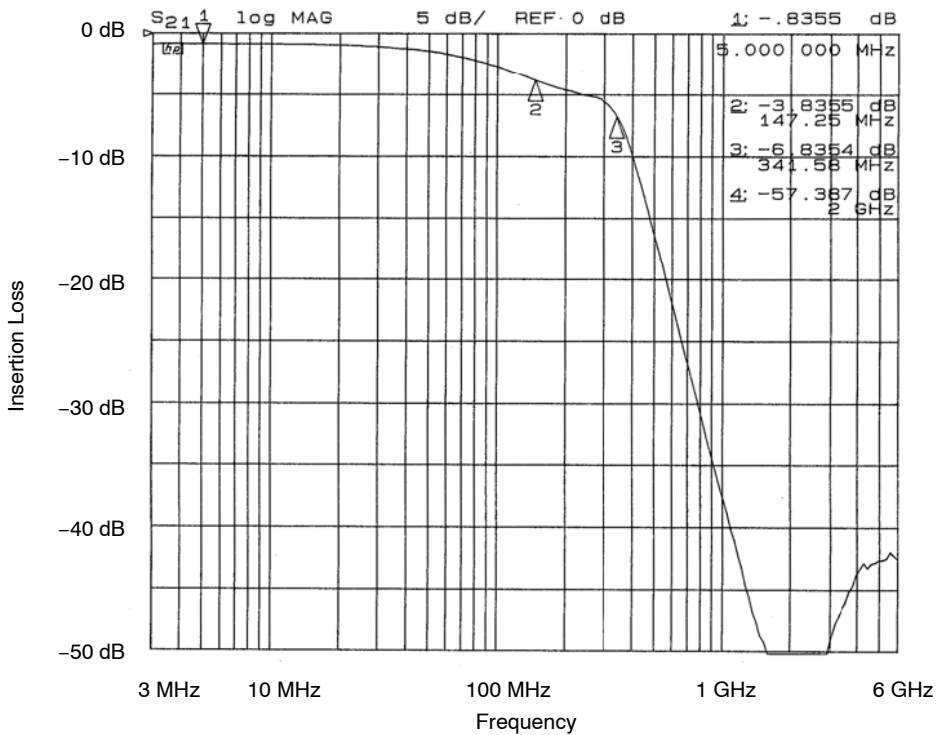


Figure 10. Filter 6 Insertion Loss (CM1460-06DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

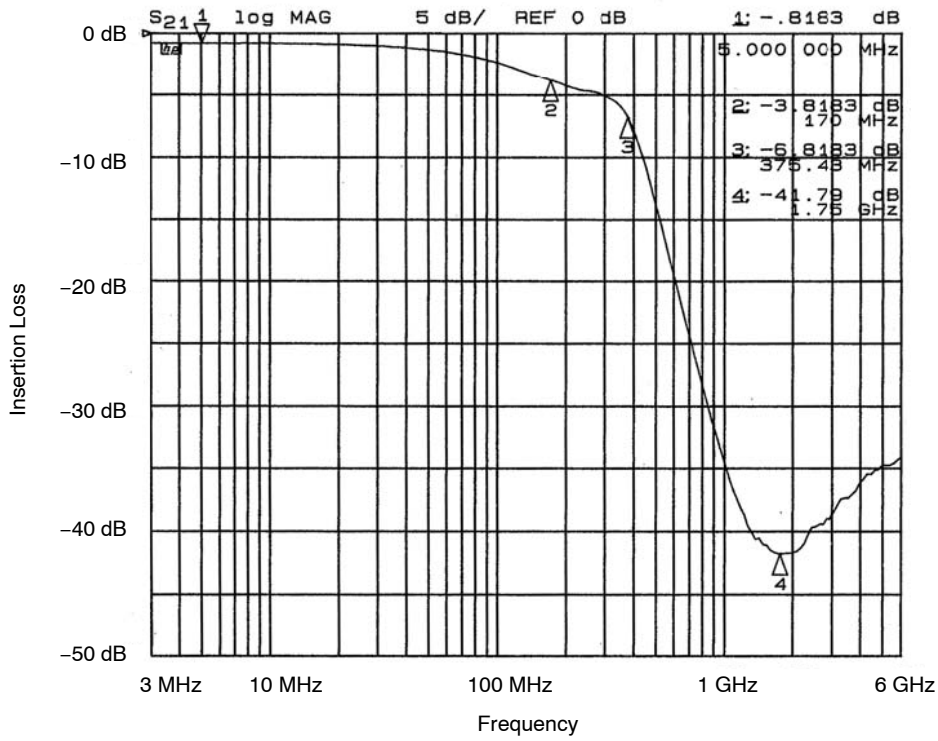


Figure 11. Filter 1 Insertion Loss (CM1460-08DE)

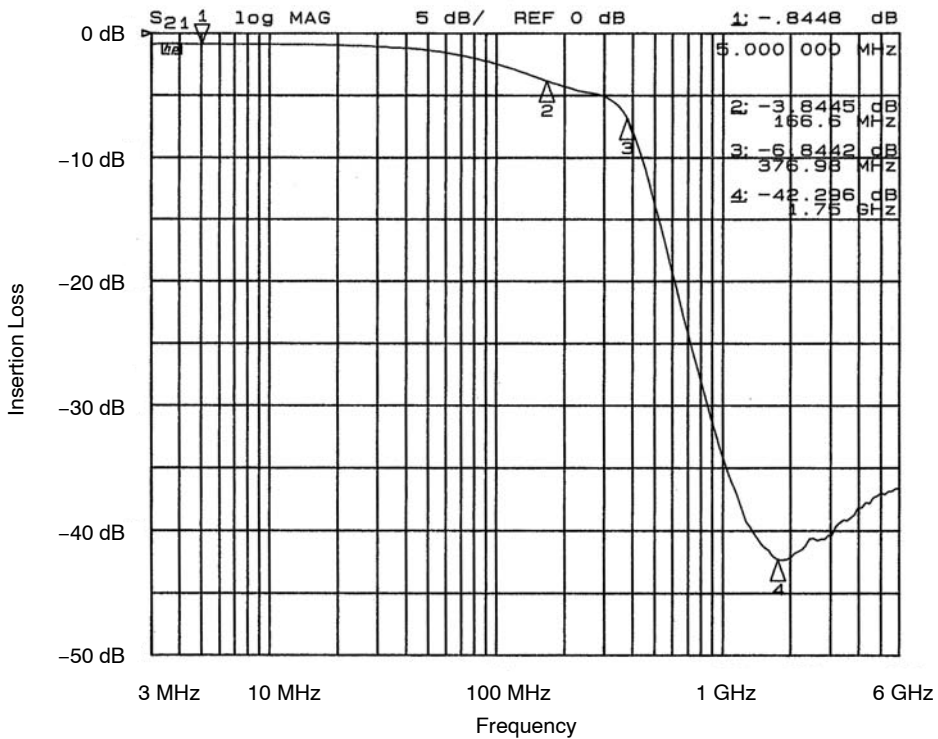


Figure 12. Filter 2 Insertion Loss (CM1460-08DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

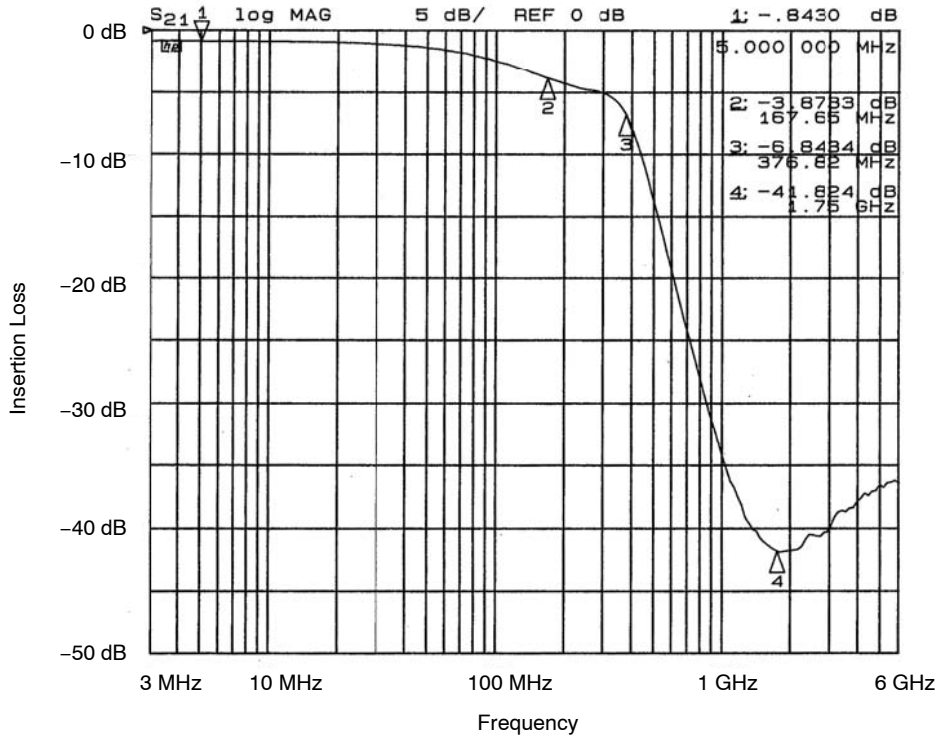


Figure 13. Filter 3 Insertion Loss (CM1460-08DE)

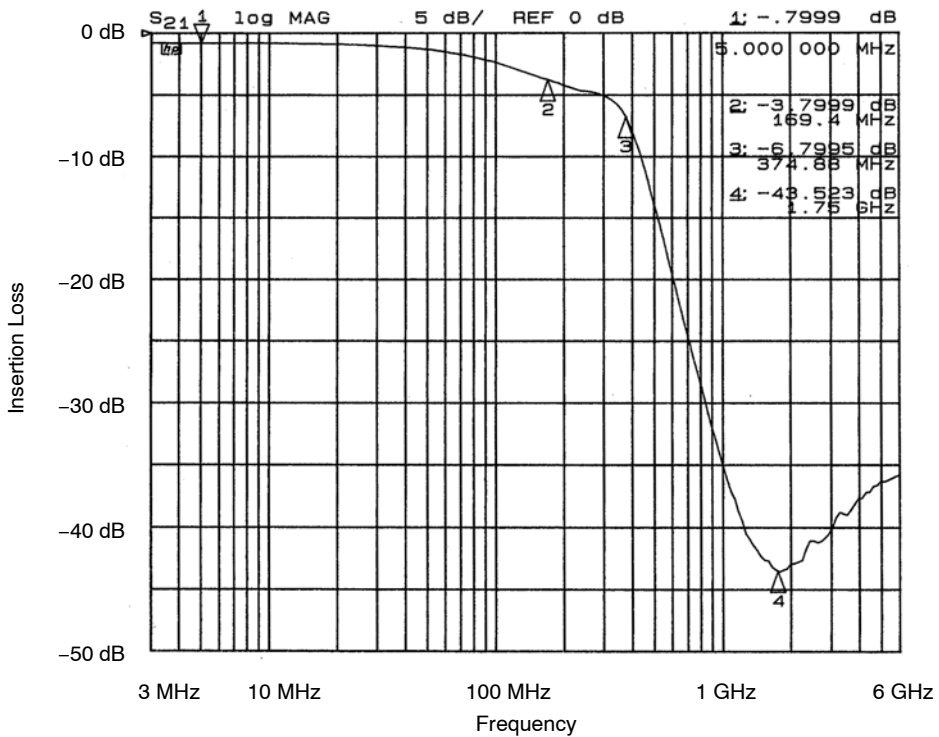


Figure 14. Filter 4 Insertion Loss (CM1460-08DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

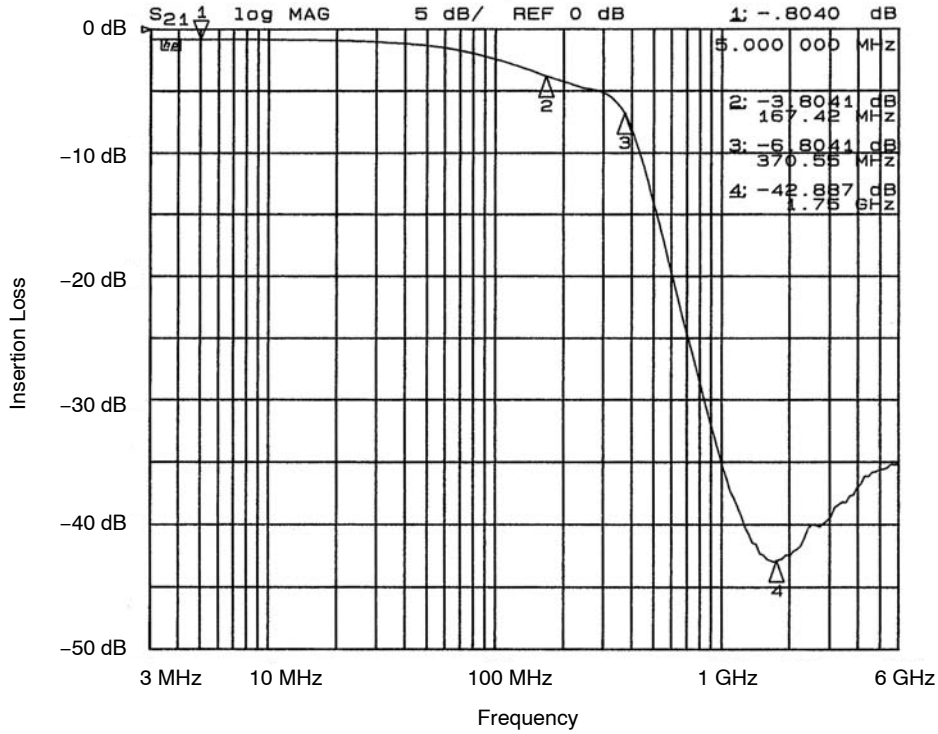


Figure 15. Filter 5 Insertion Loss (CM1460-08DE)

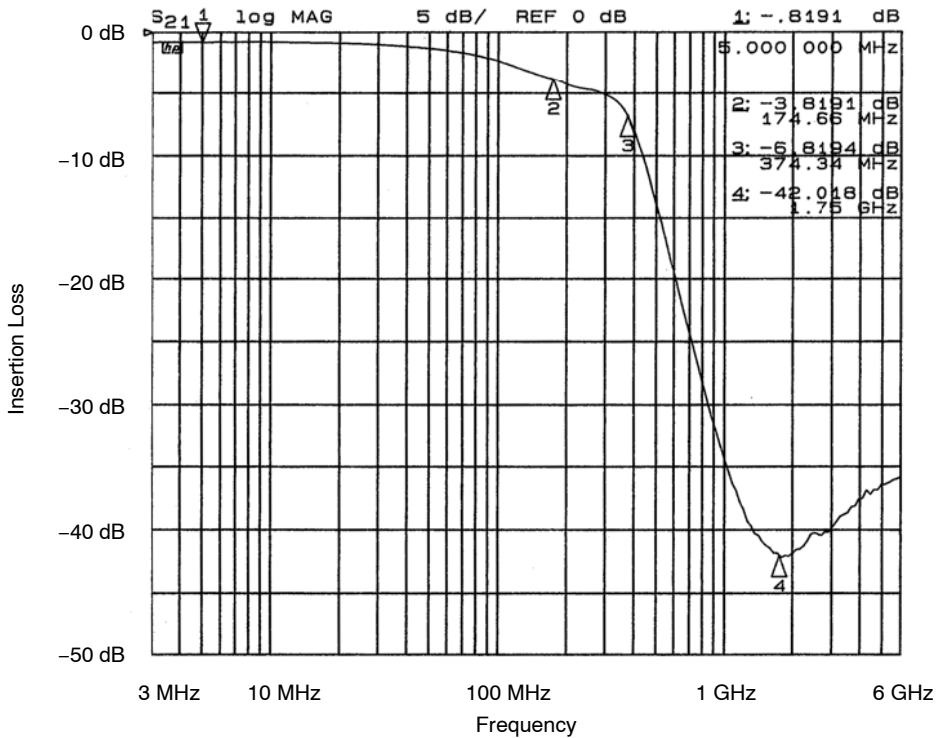


Figure 16. Filter 6 Insertion Loss (CM1460-08DE)

# CM1460

## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

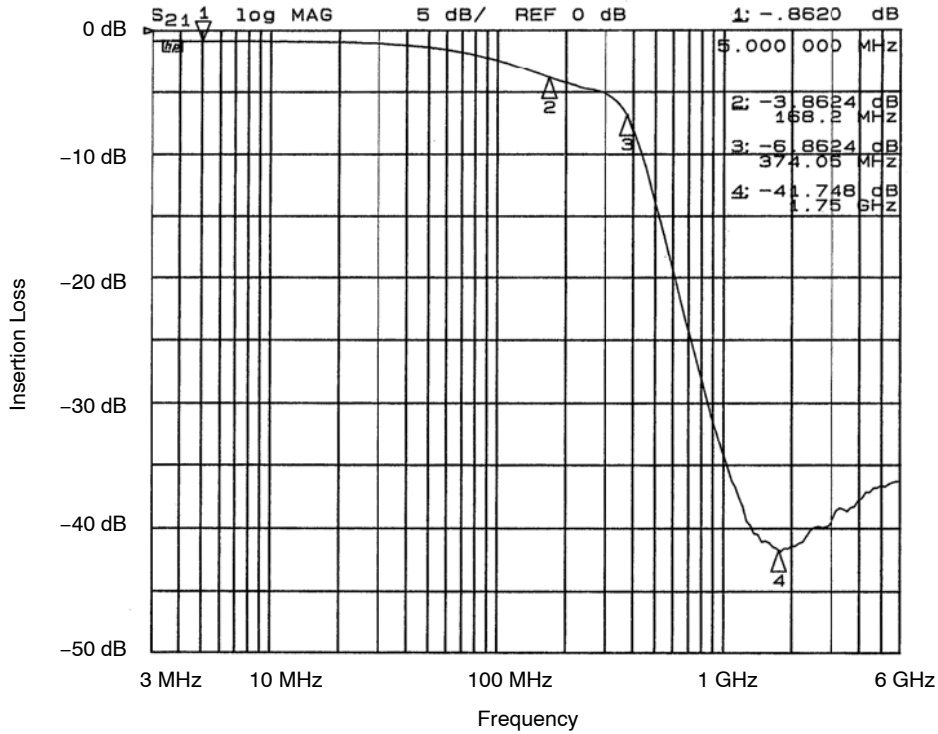


Figure 17. Filter 7 Insertion Loss (CM1460-08DE)

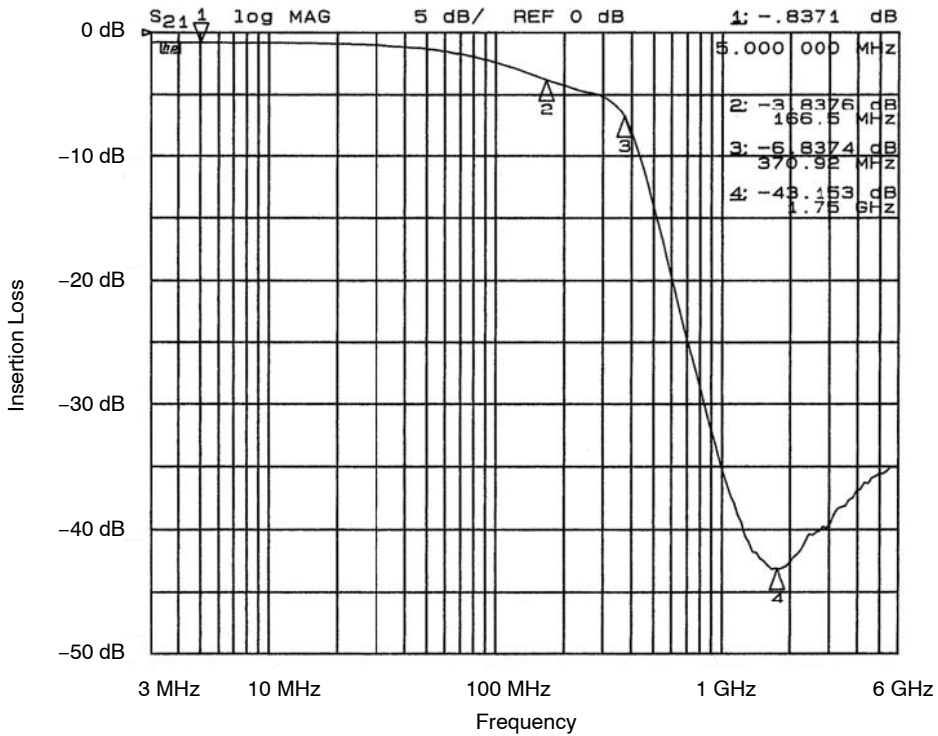
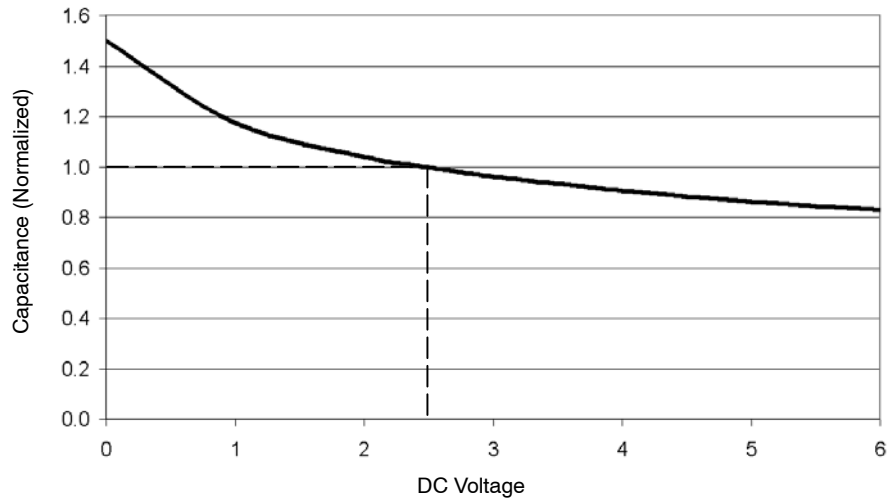


Figure 18. Filter 8 Insertion Loss (CM1460-08DE)

PERFORMANCE INFORMATION (Cont'd)

Typical Diode Capacitance vs. Input Voltage

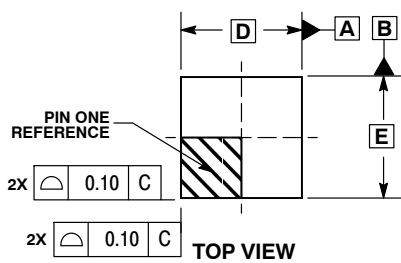


**Figure 19. Filter Capacitance vs. Input Voltage  
(normalized to capacitance at 2.5 V DC and 25°C)**

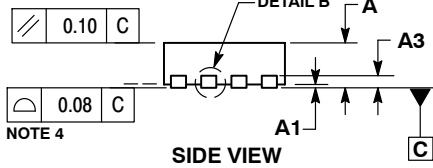
# CM1460

## PACKAGE DIMENSIONS

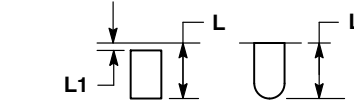
WDFN8 2x2, 0.5P  
CASE 511BE-01  
ISSUE O



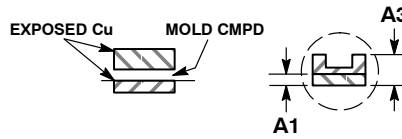
TOP VIEW



SIDE VIEW



DETAIL A  
ALTERNATE  
CONSTRUCTIONS

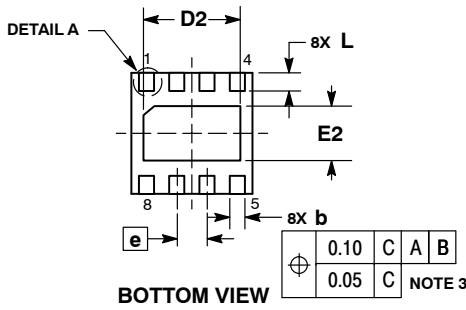


DETAIL B  
ALTERNATE  
CONSTRUCTIONS

NOTES:

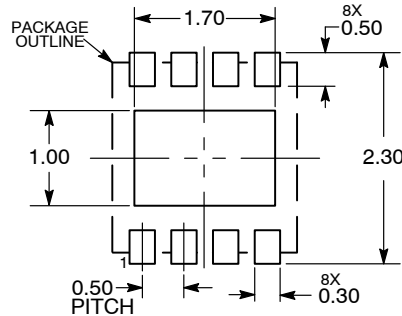
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20	REF
b	0.20	0.30
D	2.00	BSC
D2	1.50	1.70
E	2.00	BSC
E2	0.80	1.00
e	0.50	BSC
K	0.25	REF
L	0.20	0.40
L1	---	0.15



BOTTOM VIEW

### RECOMMENDED SOLDERING FOOTPRINT\*

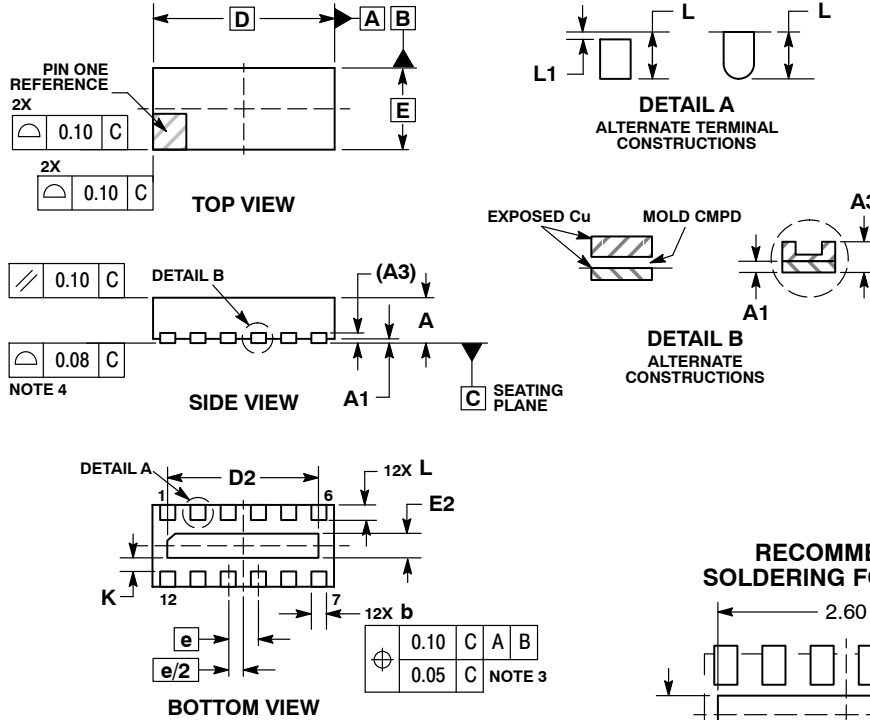


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# CM1460

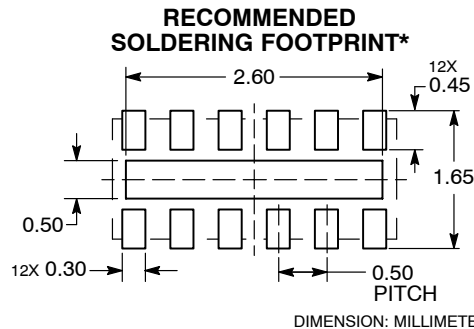
## PACKAGE DIMENSIONS

WDFN12, 3x1.35, 0.5P  
CASE 511AZ-01  
ISSUE O



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
  4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20	REF
b	0.20	0.30
D	3.00	BSC
D2	2.40	2.60
E	1.35	BSC
E2	0.30	0.50
e	0.50	BSC
K	0.22	REF
L	0.20	0.30
L1	---	0.15



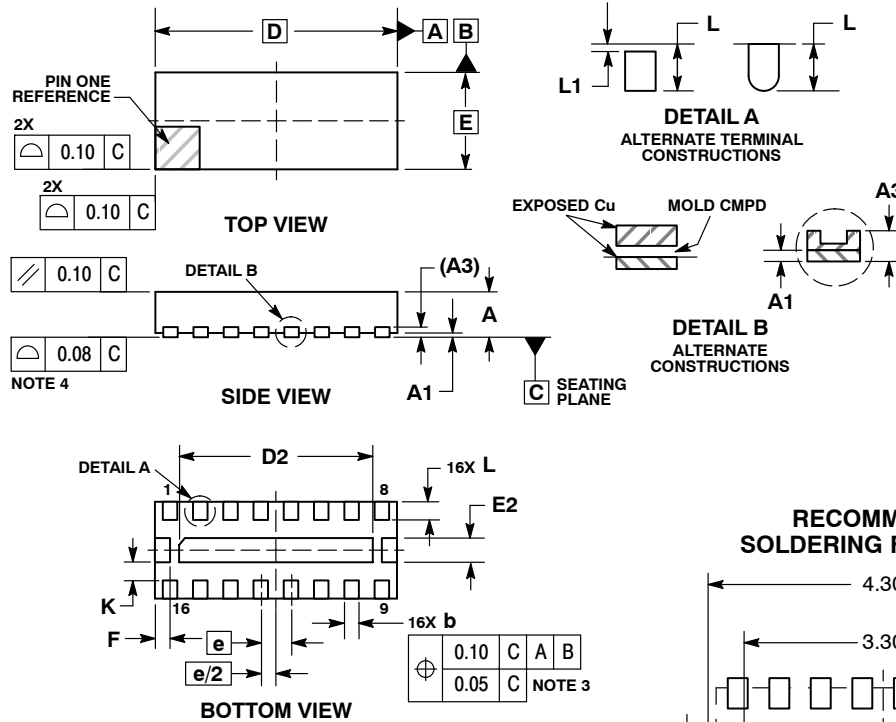
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



# CM1460

## PACKAGE DIMENSIONS

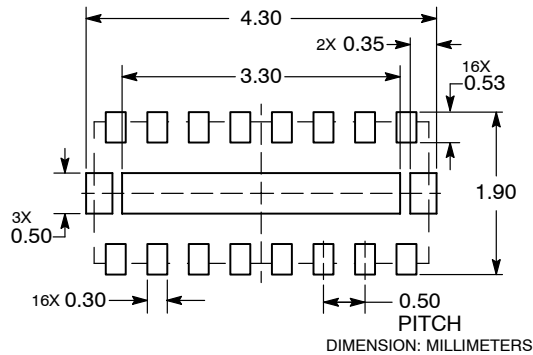
WDFN16, 4x1.6, 0.5P  
CASE 511AU-01  
ISSUE 0



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
  4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20	REF
b	0.20	0.30
D	4.00	BSC
D2	3.10	3.30
E	1.60	BSC
E2	0.30	0.50
e	0.50	BSC
F	0.25	REF
K	0.30	REF
L	0.20	0.40
L1	---	0.15

### RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PRAETORIAN is registered trademark of Semiconductor Components Industries, LCC (SCILLC).

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT:**  
Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: orderlit@onsemi.com

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5773-3850

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local Sales Representative